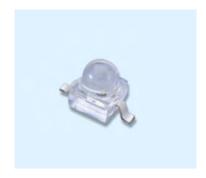


DATASHEET

SMD - A EASG2025BA0



Features

- Package in 12mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- EIA Std. package.
- Mono-color type.
- Pb-free.
- RoHS compliant
- Compliance with EU REACH.
- Compliance Halogen Free. (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

The EASG2025BA0 SMD LED is much smaller than leaded components, thus enable smaller board size, higher packing density, reduced storage space and smaller equipment to be obtained.

Applications

- Small indicator for indoor applications.
- Flat backlight for LCD, switches and symbols.
- Indicator and backlight in office equipment.
- Indicator and backlight for battery driven equipment.
- Indicator and backlight for audio and video equipment.
- Backlighting in dashboards and switches.
- Telecommunication: indicator and backlighting in telephone and fax.



Device Selection Guide

Chip Materials	Emitted Color	Resin Color
InGaN	Blue	Water Clear

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	l _F	25	mA	
Peak Forward Current	I _{FP}	100	mA	
(Duty 1/10 @1KHz) Power Dissipation	Pd	95	mW	
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +100	$^{\circ}$	
Electrostatic Discharge	ESD _{HBM}	150	V	
Soldering Temperature	T _{sol}		: 260 ℃ for 10 sec. 350 ℃ for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

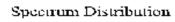
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	650	800		mcd	I _F =20mA
Viewing Angle	$2\theta_{1/2}$		25		deg	I _F =20mA
Peak Wavelength	λр		468		nm	I _F =20mA
Dominant Wavelength	λd		470		nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		25		nm	I _F =20mA
Forward Voltage	V_{F}		3.5	4.0	V	I _F =20mA
Reverse Current	I _R			50	μA	V _R =5V

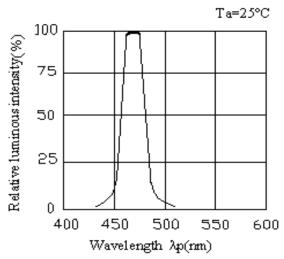
Relative luminous intensity (%)

Forward Current I, (m.A)

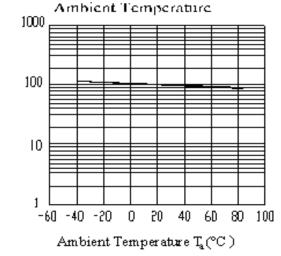


Typical Electro-Optical Characteristics Curves

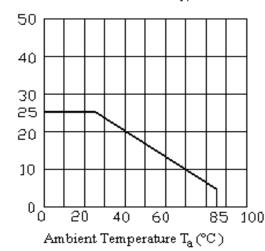




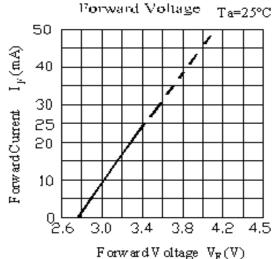
Luminous Intensity vs.



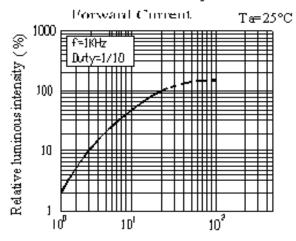
Forward Current Derating Curve



Forward Current vs.

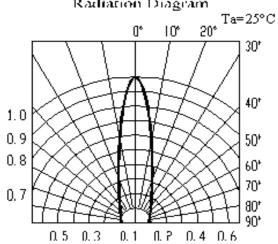


Luminous Intensity vs



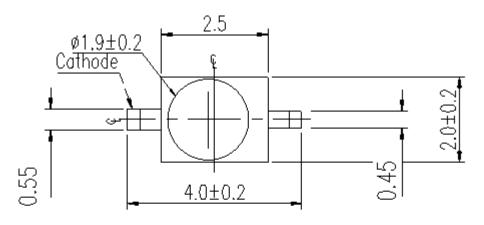
Forward Current I₁ (mA)

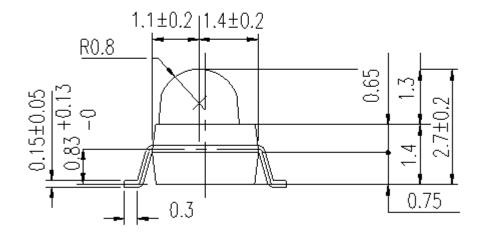
Radiation Diagram

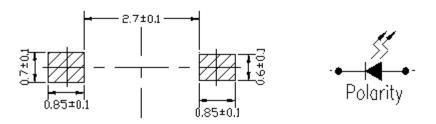




Package Outline Dimensions





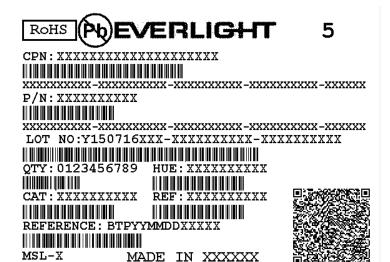


Note: The tolerances unless mentioned are ±0.1, unit=mm.



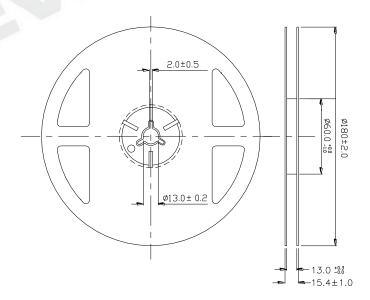
Moisture Resistant Packing Materials

Label Explanation



- CPN: Customer's Product Number
- P/N: Product NumberLOT No: Lot NumberQTY: Packing Quantity
- CAT: Luminous Intensity Rank
 HUE: Chromaticity Coordinates
 REF: Forward Voltage Rank

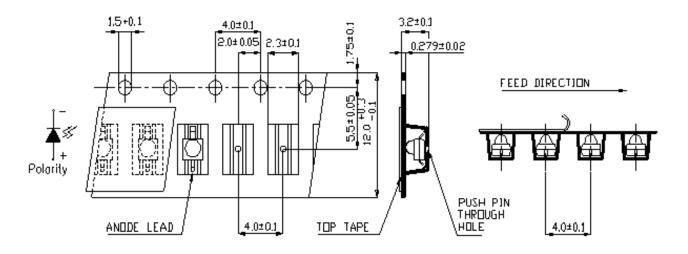
Reel & Carrier Tape Dimensions



Note: The tolerances unless mentioned are ±0.1, unit=mm

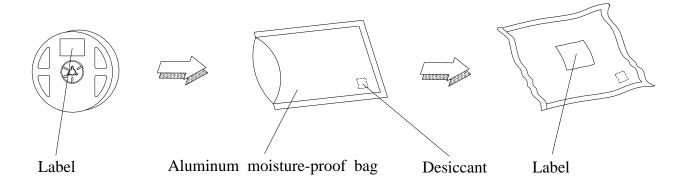


Loaded quantity 1000 PCS per reel



TR7

Note: The tolerances unless mentioned are ±0.1, unit=mm.





Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

0/1
0/1
0/1
0/1
0/1
0/1
0/1



Precautions For Use

1. Over-current-proof

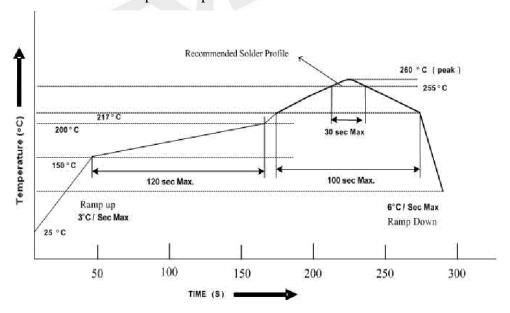
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 72 hours under 30°C or less and 60% RH or less.

 If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.



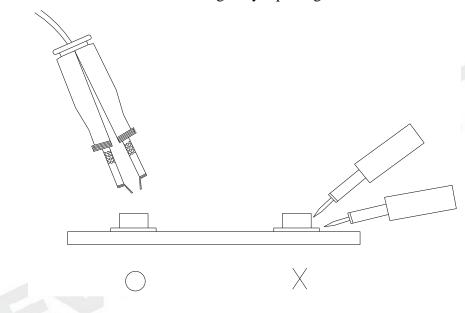
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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